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AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF CLAIMS:

Claim 1 (currently amended): A surface acoustic wave filter comprising:
a piezoelectric substrate having an input electrode pad and an output electrode pad;
a plurality of serial surface acoustic wave resonators and parallel surface acoustic wave resonators arranged in a ladder configuration between said input electrode pad and said output electrode pad on said piezoelectric substrate;
a grounded electrode pad connected to at least one of the plurality of parallel surface acoustic wave resonators; and
a grounded electrode pattern directly connected to said grounded electrode pad and arranged provided on said piezoelectric substrate so as to ~~such that~~ the grounded electrode pad and the grounded electrode pattern surround at least one of said input electrode pad and said output electrode pad on at least three sides thereof;
wherein
the grounded electrode pattern is provided between at least one of said input electrode pad and said output electrode pad and an edge of said piezoelectric substrate, such that the grounded electrode pattern is spaced from the edge of said piezoelectric substrate.

Claim 2 (currently amended): A surface acoustic wave filter according to Claim 1, wherein said grounded electrode pad and said grounded electrode pattern ~~is~~ are arranged so as to surround both of said input electrode pad and said output electrode pad on at least three sides thereof.

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Claim 3 (original): A surface acoustic wave filter according to Claim 1, wherein a portion of said grounded electrode pattern is disposed between said input electrode pad and said output electrode pad.

Claim 4 (canceled).

Claim 5 (original): A surface acoustic wave filter according to Claim 1, wherein said serial surface acoustic wave resonators are arranged so as to be generally linearly arrayed.

Claim 6 (original): A surface acoustic wave filter according to Claim 1, wherein said serial surface acoustic wave resonators and said parallel surface acoustic wave resonators are arranged in a T-shaped configuration.

Claim 7 (original): A surface acoustic wave filter according to Claim 1, wherein said piezoelectric substrate is a 36°-Y-cut-X-transmission LiTaO₃ substrate.

Claim 8 (canceled).

Claim 9 (original): A surface acoustic wave filter according to Claim 1, said plurality of serial surface acoustic wave resonators and parallel surface acoustic wave resonators include three serial surface acoustic wave resonators and two parallel surface acoustic wave resonators.

Claim 10 (original): A communication device comprising the surface acoustic wave filter according to Claim 1.

Claim 11 (currently amended): A surface acoustic wave filter comprising:
a piezoelectric substrate having an input electrode pad and an output electrode pad;

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a plurality of serial surface acoustic wave resonators and parallel surface acoustic wave resonators arranged in a ladder configuration between said input electrode pad and said output electrode pad on said piezoelectric substrate; and
a grounded electrode pad connected to at least one of the plurality of parallel surface acoustic wave resonators;

a grounded electrode pattern provided directly connected to said grounded electrode pad and arranged between at least one of said input electrode pad and said output electrode pad and an edge of said piezoelectric substrate, such that the grounded electrode pattern is spaced from the edge of said piezoelectric substrate;
wherein

the grounded electrode pattern surrounds at least one of said input electrode pad and said output electrode pad on at least two sides thereof.

Claim 12 (currently amended): A surface acoustic wave filter according to Claim 11, wherein said grounded electrode pad and said grounded electrode pattern is-are arranged on said piezoelectric substrate so as to surround at least one of said input electrode pad and said output electrode pad on at least three sides thereof.

Claim 13 (currently amended): A surface acoustic wave filter according to Claim 11, wherein said grounded electrode pad and said grounded electrode pattern is-are arranged so as to surround both of said input electrode pad and said output electrode pad on three sides thereof.

Claim 14 (original): A surface acoustic wave filter according to Claim 11, wherein a portion of said grounded electrode pattern is disposed between said input electrode pad and said output electrode pad.

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Claim 15 (original): A surface acoustic wave filter according to Claim 11, wherein said serial surface acoustic wave resonators are arranged so as to be generally linearly arrayed.

Claim 16 (original): A surface acoustic wave filter according to Claim 11, wherein said serial surface acoustic wave resonators and said parallel surface acoustic wave resonators are arranged in a T-shaped configuration.

Claim 17 (original): A surface acoustic wave filter according to Claim 11, wherein said piezoelectric substrate is a 36°-Y-cut-X-transmission LiTaO₃ substrate.

Claim 18 (canceled).

Claim 19 (original): A surface acoustic wave filter according to Claim 11, said plurality of serial surface acoustic wave resonators and parallel surface acoustic wave resonators include three serial surface acoustic wave resonators and two parallel surface acoustic wave resonators.

Claim 20 (original): A communication device comprising the surface acoustic wave filter according to Claim 11.